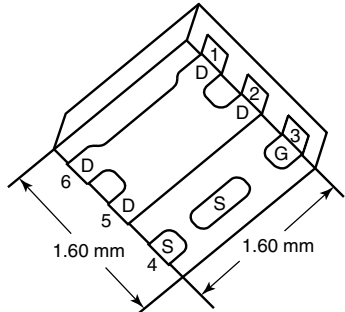


## P-Channel 20 V (D-S) MOSFET

### PRODUCT SUMMARY

| V <sub>DS</sub> (V) | R <sub>DS(on)</sub> (Ω)            | I <sub>D</sub> (A) | Q <sub>g</sub> (Typ.) |
|---------------------|------------------------------------|--------------------|-----------------------|
| - 20                | 0.035 at V <sub>GS</sub> = - 4.5 V | - g <sup>a</sup>   | 13 nC                 |
|                     | 0.049 at V <sub>GS</sub> = - 2.5 V | - g <sup>a</sup>   |                       |
|                     | 0.079 at V <sub>GS</sub> = - 1.8 V | - g <sup>a</sup>   |                       |
|                     | 0.157 at V <sub>GS</sub> = - 1.5 V | - 2                |                       |

PowerPAK SC-75-6L-Single



**Ordering Information:**  
SiB457EDK-T1-GE3 (Lead (Pb)-free and Halogen-free)

### FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- New Thermally Enhanced PowerPAK<sup>®</sup> SC-75 Package
  - Small Footprint Area
  - Low On-Resistance
- 100 % R<sub>g</sub> Tested
- Typical ESD Performance: 2500 V
- Built in ESD Protection with Zener Diode
- Compliant to RoHS Directive 2011/65/EU

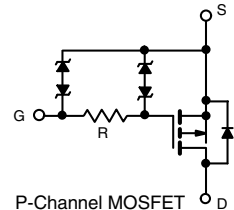
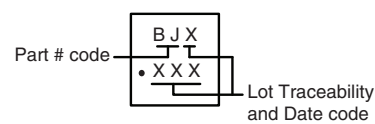


**RoHS**  
COMPLIANT  
HALOGEN  
FREE

### APPLICATIONS

- Load Switch for Portable Devices
- Load Switch for Charging Circuits

#### Marking Code



### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)

| Parameter                                                    | Symbol                            | Limit                  | Unit                  |
|--------------------------------------------------------------|-----------------------------------|------------------------|-----------------------|
| Drain-Source Voltage                                         | V <sub>DS</sub>                   | - 20                   | V                     |
| Gate-Source Voltage                                          | V <sub>GS</sub>                   | ± 8                    | V                     |
| Continuous Drain Current (T <sub>J</sub> = 150 °C)           | I <sub>D</sub>                    | T <sub>C</sub> = 25 °C | - 9 <sup>a</sup>      |
|                                                              |                                   | T <sub>C</sub> = 70 °C | - 9 <sup>a</sup>      |
|                                                              |                                   | T <sub>A</sub> = 25 °C | - 6.8 <sup>b, c</sup> |
|                                                              |                                   | T <sub>A</sub> = 70 °C | - 5.5 <sup>b, c</sup> |
| Pulsed Drain Current                                         | I <sub>DM</sub>                   | - 25                   | A                     |
| Continuous Source-Drain Diode Current                        | I <sub>S</sub>                    | T <sub>C</sub> = 25 °C | - 9 <sup>a</sup>      |
|                                                              |                                   | T <sub>A</sub> = 25 °C | - 2 <sup>b, c</sup>   |
| Maximum Power Dissipation                                    | P <sub>D</sub>                    | T <sub>C</sub> = 25 °C | 13                    |
|                                                              |                                   | T <sub>C</sub> = 70 °C | 8.4                   |
|                                                              |                                   | T <sub>A</sub> = 25 °C | 2.4 <sup>b, c</sup>   |
|                                                              |                                   | T <sub>A</sub> = 70 °C | 1.6 <sup>b, c</sup>   |
| Operating Junction and Storage Temperature Range             | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 150            | °C                    |
| Soldering Recommendations (Peak Temperature) <sup>d, e</sup> |                                   | 260                    |                       |

### THERMAL RESISTANCE RATINGS

| Parameter                                   | Symbol            | Typical | Maximum | Unit |
|---------------------------------------------|-------------------|---------|---------|------|
| Maximum Junction-to-Ambient <sup>b, f</sup> | R <sub>thJA</sub> | 41      | 51      | °C/W |
| Maximum Junction-to-Case (Drain)            | R <sub>thJC</sub> | 7.5     | 9.5     |      |

Notes:

- Package limited.
- Surface mounted on 1" x 1" FR4 board.
- t = 5 s.
- See solder profile ([www.vishay.com/doc?73257](http://www.vishay.com/doc?73257)). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- Maximum under steady state conditions is 105 °C/W.

| SPECIFICATIONS (T <sub>J</sub> = 25 °C, unless otherwise noted) |                                      |                                                                                                                                |       |        |       |       |  |
|-----------------------------------------------------------------|--------------------------------------|--------------------------------------------------------------------------------------------------------------------------------|-------|--------|-------|-------|--|
| Parameter                                                       | Symbol                               | Test Conditions                                                                                                                | Min.  | Typ.   | Max.  | Unit  |  |
| Static                                                          |                                      |                                                                                                                                |       |        |       |       |  |
| Drain-Source Breakdown Voltage                                  | V <sub>DS</sub>                      | V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA                                                                               | - 20  |        |       | V     |  |
| V <sub>DS</sub> Temperature Coefficient                         | ΔV <sub>DS</sub> /T <sub>J</sub>     | I <sub>D</sub> = - 250 μA                                                                                                      |       | - 12   |       | mV/°C |  |
| V <sub>GS(th)</sub> Temperature Coefficient                     | ΔV <sub>GS(th)</sub> /T <sub>J</sub> |                                                                                                                                |       | 2.5    |       |       |  |
| Gate-Source Threshold Voltage                                   | V <sub>GS(th)</sub>                  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA                                                                  | - 0.4 |        | - 1   | V     |  |
| Gate-Source Leakage                                             | I <sub>GSS</sub>                     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 8 V                                                                                 |       |        | ± 5   | μA    |  |
|                                                                 |                                      | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 4.5 V                                                                               |       |        | ± 0.5 |       |  |
| Zero Gate Voltage Drain Current                                 | I <sub>DSS</sub>                     | V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V                                                                                |       |        | - 1   |       |  |
|                                                                 |                                      | V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C                                                        |       |        | - 10  |       |  |
| On-State Drain Current <sup>a</sup>                             | I <sub>D(on)</sub>                   | V <sub>DS</sub> ≤ - 5 V, V <sub>GS</sub> = - 4.5 V                                                                             | - 15  |        |       | A     |  |
| Drain-Source On-State Resistance <sup>a</sup>                   | R <sub>DS(on)</sub>                  | V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4.8 A                                                                            |       | 0.029  | 0.035 | Ω     |  |
|                                                                 |                                      | V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 4 A                                                                              |       | 0.040  | 0.049 |       |  |
|                                                                 |                                      | V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 3.3 A                                                                            |       | 0.060  | 0.079 |       |  |
|                                                                 |                                      | V <sub>GS</sub> = - 1.5 V, I <sub>D</sub> = - 1.5 A                                                                            |       | 0.085  | 0.157 |       |  |
| Forward Transconductance <sup>a</sup>                           | g <sub>fs</sub>                      | V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 4.8 A                                                                             |       | 16     |       | S     |  |
| Dynamic <sup>b</sup>                                            |                                      |                                                                                                                                |       |        |       |       |  |
| Total Gate Charge                                               | Q <sub>g</sub>                       | V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 8 V, I <sub>D</sub> = - 6.8 A                                                    |       | 22     | 44    | nC    |  |
| Gate-Source Charge                                              |                                      | V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 6.8 A                                                  |       | 13     | 26    |       |  |
|                                                                 | Q <sub>gs</sub>                      |                                                                                                                                |       | 1.2    |       |       |  |
| Gate-Drain Charge                                               | Q <sub>gd</sub>                      |                                                                                                                                |       | 3      |       |       |  |
| Gate Resistance                                                 | R <sub>g</sub>                       | f = 1 MHz                                                                                                                      | 0.28  | 1.4    | 2.8   | kΩ    |  |
| Turn-On Delay Time                                              | t <sub>d(on)</sub>                   | V <sub>DD</sub> = - 10 V, R <sub>L</sub> = 1.8 Ω<br>I <sub>D</sub> ≅ - 5.5 A, V <sub>GEN</sub> = - 4.5 V, R <sub>g</sub> = 1 Ω |       | 0.34   | 0.51  | μs    |  |
| Rise Time                                                       | t <sub>r</sub>                       |                                                                                                                                |       | 0.90   | 1.35  |       |  |
| Turn-Off Delay Time                                             | t <sub>d(off)</sub>                  |                                                                                                                                |       | 3      | 4.5   |       |  |
| Fall Time                                                       | t <sub>f</sub>                       |                                                                                                                                |       | 1.90   | 2.90  |       |  |
| Turn-On Delay Time                                              | t <sub>d(on)</sub>                   | V <sub>DD</sub> = - 10 V, R <sub>L</sub> = 1.8 Ω<br>I <sub>D</sub> ≅ - 5.5 A, V <sub>GEN</sub> = - 8 V, R <sub>g</sub> = 1 Ω   |       | 0.17   | 0.26  |       |  |
| Rise Time                                                       | t <sub>r</sub>                       |                                                                                                                                |       | 0.45   | 0.70  |       |  |
| Turn-Off Delay Time                                             | t <sub>d(off)</sub>                  |                                                                                                                                |       | 5.5    | 8.30  |       |  |
| Fall Time                                                       | t <sub>f</sub>                       |                                                                                                                                |       | 2      | 3.5   |       |  |
| Drain-Source Body Diode Characteristics                         |                                      |                                                                                                                                |       |        |       |       |  |
| Continuous Source-Drain Diode Current                           | I <sub>S</sub>                       | T <sub>C</sub> = 25 °C                                                                                                         |       |        | - 9   | A     |  |
| Pulse Diode Forward Current                                     | I <sub>SM</sub>                      |                                                                                                                                |       |        | - 25  |       |  |
| Body Diode Voltage                                              | V <sub>SD</sub>                      | I <sub>S</sub> = - 5.5 A, V <sub>GS</sub> = 0 V                                                                                |       | - 0.85 | - 1.2 | V     |  |

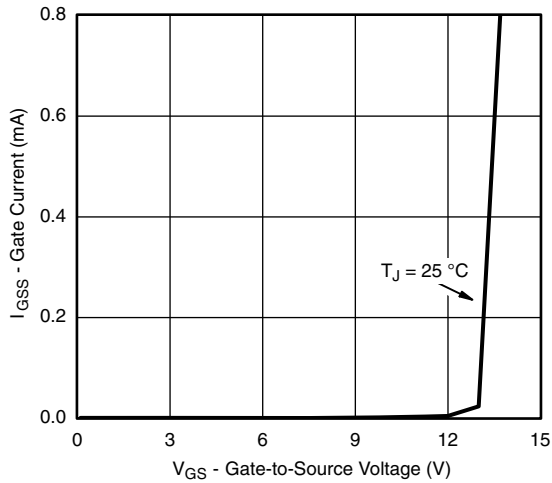
Notes:

a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

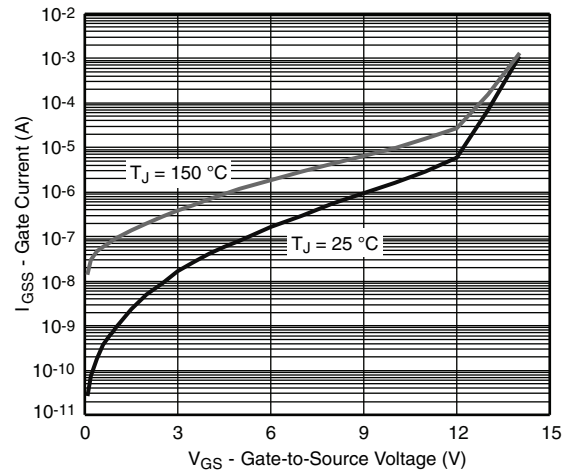
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

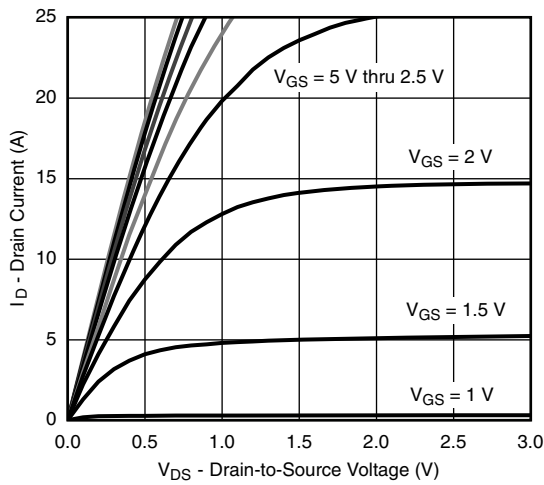
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



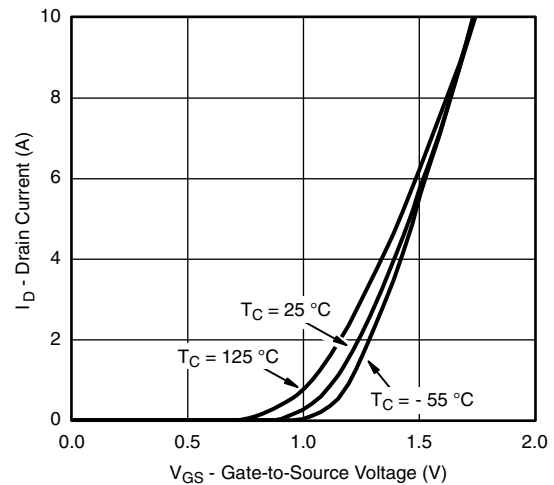
**Gate Current vs. Gate-Source Voltage**



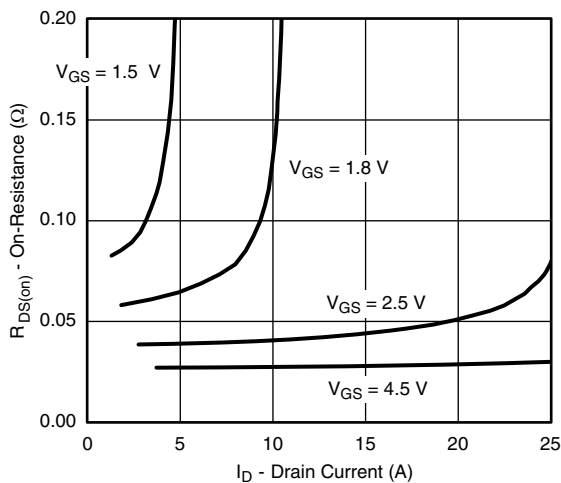
**Gate Current vs. Gate-Source Voltage**



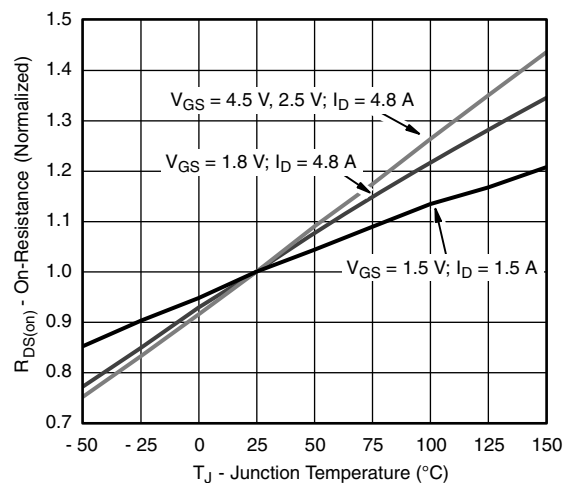
**Output Characteristics**



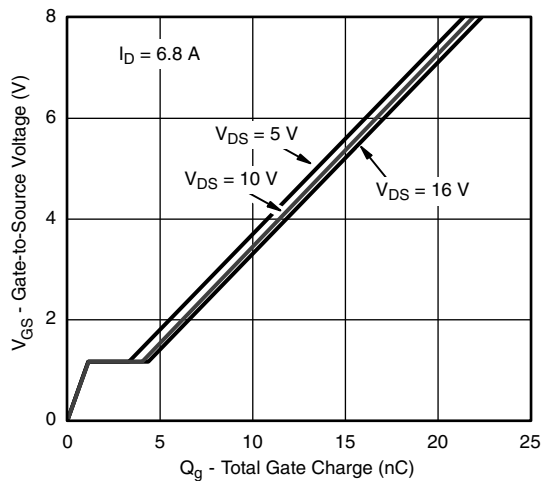
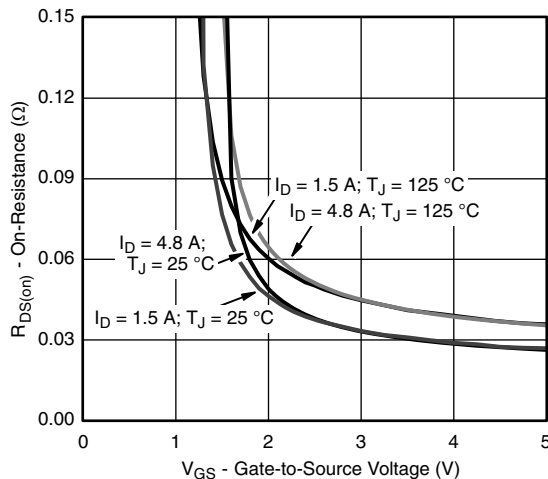
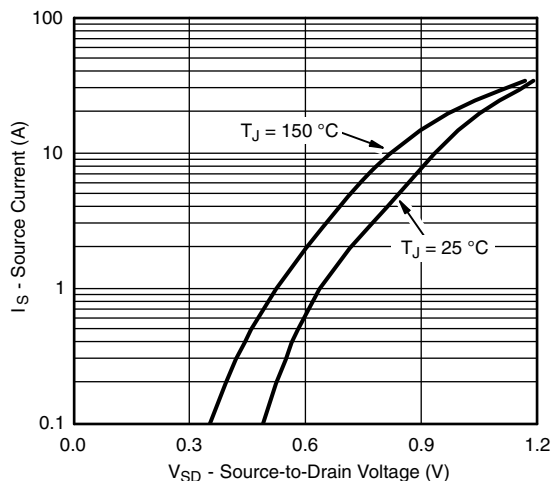
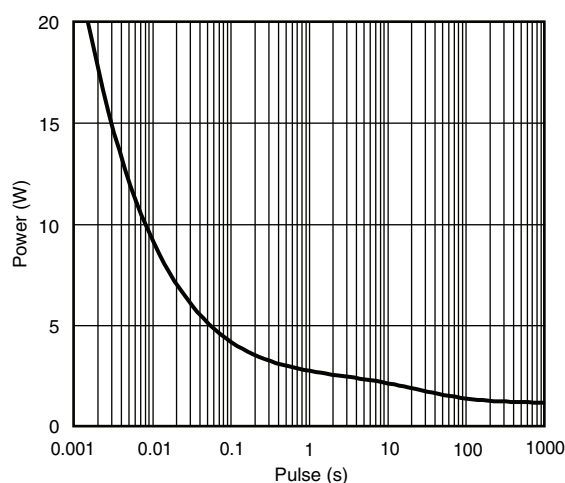
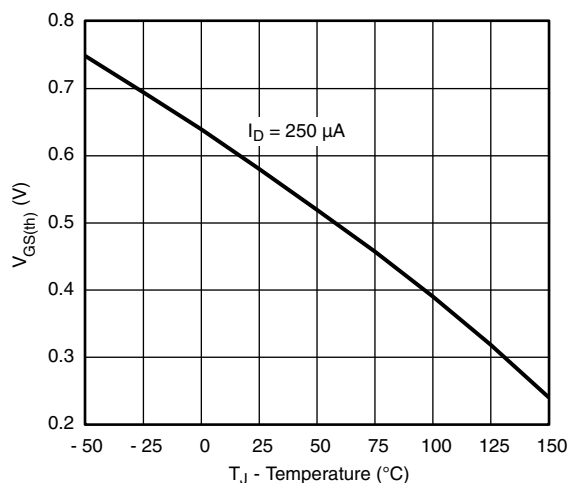
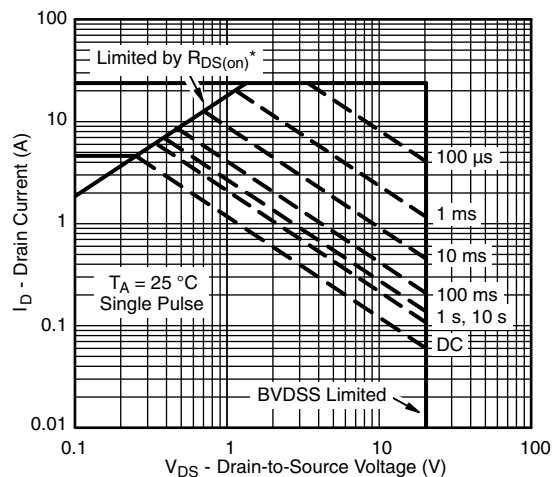
**Transfer Characteristics**



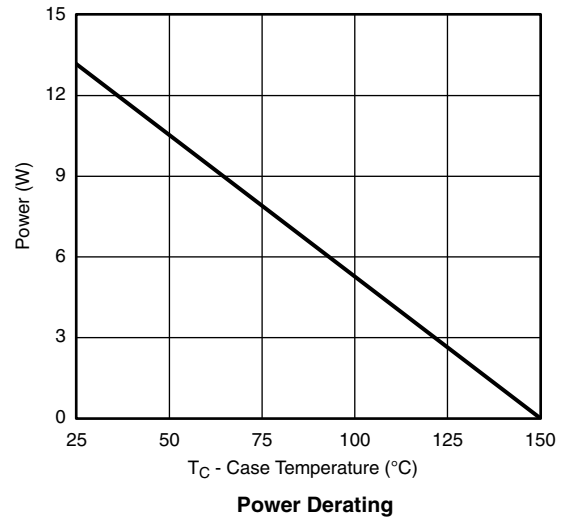
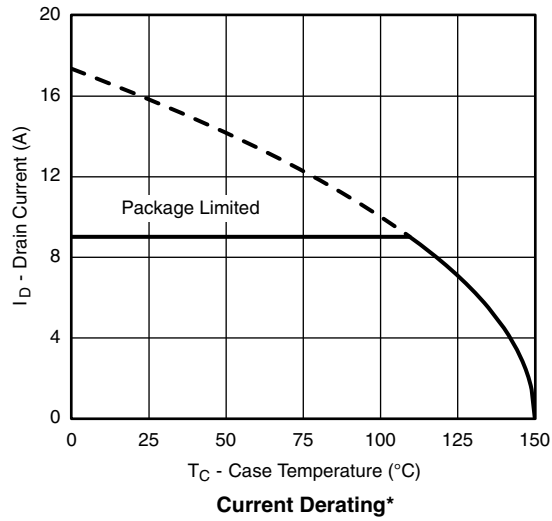
**On-Resistance vs. Drain Current**



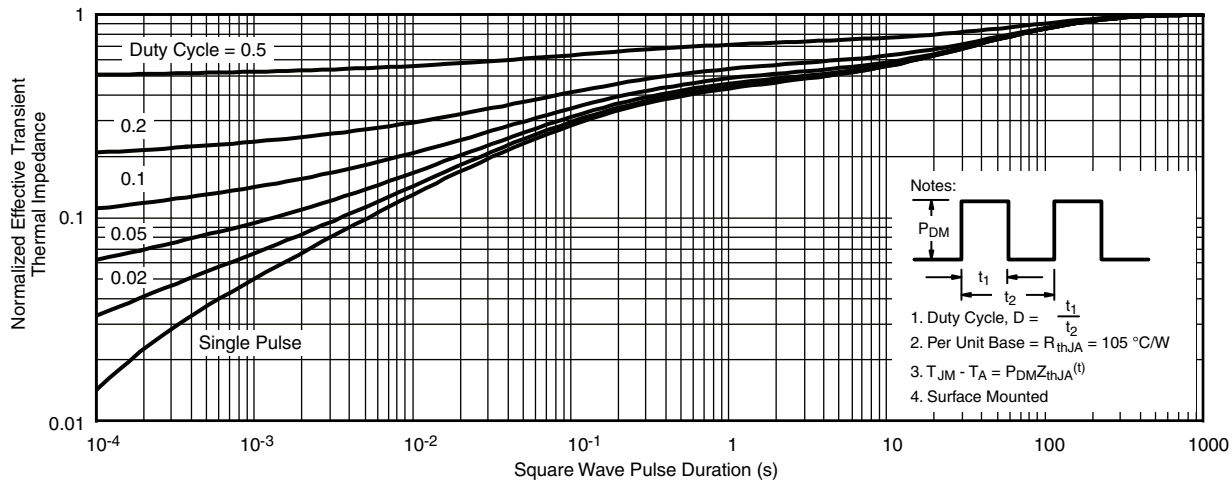
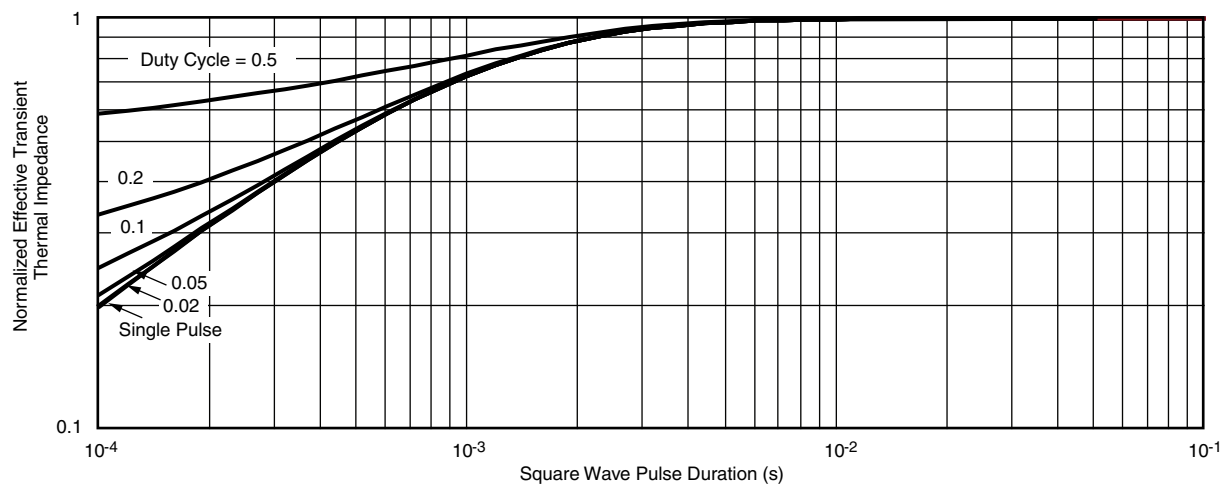
**On-Resistance vs. Junction Temperature**

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)**Gate Charge****On-Resistance vs. Gate-to-Source Voltage****Source-Drain Diode Forward Voltage****Single Pulse Power, Junction-to-Ambient****Threshold Voltage****Safe Operating Area, Junction-to-Ambient**

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)**Normalized Thermal Transient Impedance, Junction-to-Ambient****Normalized Thermal Transient Impedance, Junction-to-Case**

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see [www.vishay.com/ppg?64816](http://www.vishay.com/ppg?64816).



## PowerPAK® SC75-6L



- Notes:
1. All dimensions are in millimeters
  2. Package outline exclusive of mold flash and metal burr
  3. Package outline inclusive of plating

| DIM | SINGLE PAD  |      |      |           |       |       | DUAL PAD    |      |      |           |       |       |
|-----|-------------|------|------|-----------|-------|-------|-------------|------|------|-----------|-------|-------|
|     | MILLIMETERS |      |      | INCHES    |       |       | MILLIMETERS |      |      | INCHES    |       |       |
|     | Min         | Nom  | Max  | Min       | Nom   | Max   | Min         | Nom  | Max  | Min       | Nom   | Max   |
| A   | 0.675       | 0.75 | 0.80 | 0.027     | 0.030 | 0.032 | 0.675       | 0.75 | 0.80 | 0.027     | 0.030 | 0.032 |
| A1  | 0           | -    | 0.05 | 0         | -     | 0.002 | 0           | -    | 0.05 | 0         | -     | 0.002 |
| b   | 0.18        | 0.25 | 0.33 | 0.007     | 0.010 | 0.013 | 0.18        | 0.25 | 0.33 | 0.007     | 0.010 | 0.013 |
| C   | 0.15        | 0.20 | 0.25 | 0.006     | 0.008 | 0.010 | 0.15        | 0.20 | 0.25 | 0.006     | 0.008 | 0.010 |
| D   | 1.53        | 1.60 | 1.70 | 0.060     | 0.063 | 0.067 | 1.53        | 1.60 | 1.70 | 0.060     | 0.063 | 0.067 |
| D1  | 0.57        | 0.67 | 0.77 | 0.022     | 0.026 | 0.030 | 0.34        | 0.44 | 0.54 | 0.013     | 0.017 | 0.021 |
| D2  | 0.10        | 0.20 | 0.30 | 0.004     | 0.008 | 0.012 |             |      |      |           |       |       |
| E   | 1.53        | 1.60 | 1.70 | 0.060     | 0.063 | 0.067 | 1.53        | 1.60 | 1.70 | 0.060     | 0.063 | 0.067 |
| E1  | 1.00        | 1.10 | 1.20 | 0.039     | 0.043 | 0.047 | 0.51        | 0.61 | 0.71 | 0.020     | 0.024 | 0.028 |
| E2  | 0.20        | 0.25 | 0.30 | 0.008     | 0.010 | 0.012 |             |      |      |           |       |       |
| E3  | 0.32        | 0.37 | 0.42 | 0.013     | 0.015 | 0.017 |             |      |      |           |       |       |
| e   | 0.50 BSC    |      |      | 0.020 BSC |       |       | 0.50 BSC    |      |      | 0.020 BSC |       |       |
| K   | 0.180 TYP   |      |      | 0.007 TYP |       |       | 0.245 TYP   |      |      | 0.010 TYP |       |       |
| K1  | 0.275 TYP   |      |      | 0.011 TYP |       |       | 0.320 TYP   |      |      | 0.013 TYP |       |       |
| K2  | 0.200 TYP   |      |      | 0.008 TYP |       |       | 0.200 BSC   |      |      | 0.008 TYP |       |       |
| K3  | 0.255 TYP   |      |      | 0.010 TYP |       |       |             |      |      |           |       |       |
| K4  | 0.300 TYP   |      |      | 0.012 TYP |       |       |             |      |      |           |       |       |
| L   | 0.15        | 0.25 | 0.35 | 0.006     | 0.010 | 0.014 | 0.15        | 0.25 | 0.35 | 0.006     | 0.010 | 0.014 |
| T   |             |      |      |           |       |       | 0.03        | 0.08 | 0.13 | 0.001     | 0.003 | 0.005 |

ECN: C-07431 – Rev. C, 06-Aug-07  
DWG: 5935

Technical drawing of a mechanical part, showing dimensions in mm and inches. The drawing includes a central rectangular feature with a central vertical slot and a central horizontal slot. The overall dimensions are 2.000 (0.079) in width and 1.700 (0.067) in height. The central vertical slot is 0.250 (0.01) in width and 0.400 (0.016) in height. The central horizontal slot is 0.300 (0.012) in height and 0.670 (0.026) in width. The drawing also shows various other dimensions for the features and slots, such as 0.250 (0.01), 0.300 (0.012), 0.400 (0.016), 0.500 (0.02), 0.620 (0.024), 0.670 (0.026), 0.700 (0.028), 0.750 (0.030), 0.800 (0.031), 0.850 (0.033), 0.900 (0.035), 0.950 (0.037), 1.000 (0.039), 1.050 (0.041), 1.100 (0.043), 1.150 (0.045), 1.200 (0.047), 1.250 (0.049), 1.300 (0.051), 1.350 (0.053), 1.400 (0.055), 1.450 (0.057), 1.500 (0.059), 1.550 (0.061), 1.600 (0.063), 1.650 (0.065), 1.700 (0.067), 1.750 (0.069), 1.800 (0.071), 1.850 (0.073), 1.900 (0.075), 1.950 (0.077), 2.000 (0.079).

Dimensions in mm/(Inches)

APPLICATION NOTE



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

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**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.**

**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**

**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.**